

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KONGLIN CONSTRUCTION & MANUFACTURING CO., LTD	04/09/2007
RECEIVING PARTY DATA	
Name:	Advanced Thermal Device Inc.
Street Address:	B2F, No.3, Wanning St., Wunshan District,
City:	Taipei City
State/Country:	TAIWAN
Postal Code:	116
PROPERTY NUMBERS Total: 3	
Property Type	Number
Application Number:	10710663
Application Number:	11626382
Application Number:	11307685
CORRESPONDENCE DATA	
Fax Number:	(949)660-0809
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	+886-2-23692800
Email:	USA@JCIPGROUP.COM.TW
Correspondent Name:	JIANQ CHYUN INTELLECTUAL PROPERTY OFFICE
Address Line 1:	7F.-1, NO. 100, ROOSEVELT RD., SEC. 2
Address Line 4:	TAIPEI, TAIWAN 100
ATTORNEY DOCKET NUMBER:	12262-12262_1-15390
NAME OF SUBMITTER:	Belinda Lee
Total Attachments: 3 source=ASSIGNMENT_ATD#page1.tif	

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PATENT
REEL: 019271 FRAME: 0350

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ASSIGNMENT OF PATENTS AND PATENT APPLICATIONS

KONGLIN CONSTRUCTION & MANUFACTURING CO., LTD., a Taiwan corporation having a place of business at B2F, NO. 207, SEC.3, Beisin Rd., Sindian City, Taipei Country, 231 Taiwan (R.O.C) (hereafter ASSIGNOR) has been assigned or otherwise has an ownership interest in certain new and useful improvements as set forth in the patents and patent applications listed below:

Title :	Filed	Application No.
HEAT TRANSFER DEVICE	July 27, 2004	10/710,663

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR hereby:

- 1) Sell(s), assign(s) and transfer(s) to **Advanced Thermal Device Inc.**, a Taiwan corporation having a place of business at B2F, No.3, Wanning St., Wunshan District, Taipei City 116, Taiwan (R.O.C.) (hereinafter referred to as "ASSIGNEE") the entire right, title and interest in any and all improvements and inventions disclosed in, application(s) based upon, and Patent(s) (including foreign patents) granted upon the information which is disclosed therein.
- 2) Authorize and request the Commissioner of Patents to issue any and all Letters Patents resulting from said application(s) or any division(s), continuation(s), substitute(s), re-examination(s) or reissue(s) thereof to the ASSIGNEE.
- 3) Agree to execute all papers and documents and, entirely at the ASSIGNEE's expense, perform any acts which are reasonably necessary in connection with the prosecution of said application(s), as well as any derivative and applications thereof, foreign applications based thereon, and/or the enforcement of patents resulting from such applications.
- 4) Agree that the terms, covenants and conditions of this assignment shall inure to the benefit of the ASSIGNEE, its successors, assigns and other legal representative(s), and shall be binding upon the inventor(s), as well as the inventor's heirs, legal representatives and assigns.
- 5) Warrant and represent that ASSIGNOR has not entered, and will not enter into any assignment, contract, or understanding that conflicts with this assignment.

Signed on the date(s) indicated beside my (our) signature(s).

By:  Date: April 9, 2007
Typed Name: Mei-Tung Lin
Title: President
Company: KONGLIN CONSTRUCTION & MANUFACTURING CO., LTD.

ASSIGNMENT OF PATENTS AND PATENT APPLICATIONS

KONGLIN CONSTRUCTION & MANUFACTURING CO., LTD., a Taiwan corporation having a place of business at B2F, NO. 207, SEC.3, Beisin Rd., Sindian City, Taipei Country, 231 Taiwan (R.O.C) (hereafter ASSIGNOR) has been assigned or otherwise has an ownership interest in certain new and useful improvements as set forth in the patents and patent applications listed below:

Title :	Filed	Application No.
METHOD OF MANUFACTURING HEAT TRANSFER DEVICE	January 24, 2007	11/626,382

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR hereby:

- 1) Sell(s), assign(s) and transfer(s) to **Advanced Thermal Device Inc.**, a Taiwan corporation having a place of business at B2F, No.3, Wanning St., Wunshan District, Taipei City 116, Taiwan (R.O.C.) (hereinafter referred to as "ASSIGNEE") the entire right, title and interest in any and all improvements and inventions disclosed in, application(s) based upon, and Patent(s) (including foreign patents) granted upon the information which is disclosed therein.
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By: 
Typed Name: Mei-Tung Lin
Title: President
Company: KONGLIN CONSTRUCTION & MANUFACTURING CO.,
LTD.

Date: April 9, 2007

ASSIGNMENT OF PATENTS AND PATENT APPLICATIONS

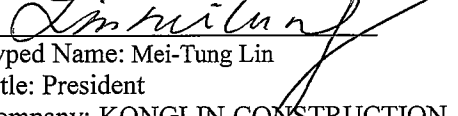
KONGLIN CONSTRUCTION & MANUFACTURING CO., LTD., a Taiwan corporation having a place of business at B2F, NO. 207, SEC.3, Beisin Rd., Sindian City, Taipei Country, 231 Taiwan (R.O.C) (hereafter ASSIGNOR) has been assigned or otherwise has an ownership interest in certain new and useful improvements as set forth in the patents and patent applications listed below:

Title :	Filed	Application No.
HEAT PIPE COOLING SYSTEM AND	February 17, 2006	11/307,685
THERMAL CONNECTOR THEREOF		

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, ASSIGNOR hereby:

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